

### 3.0x2.0mm SURFACE MOUNT LED LAMP

Part Number: AA3020SECK

Super Bright Orange

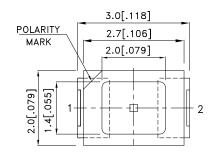
### **Features**

- 3.0mm x 2.0mm, 1.4mm high, only minimum space required.
- Suitable for compact optoelectronic applications.
- Low power consumption.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.

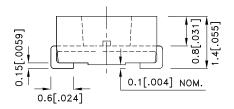
### Description

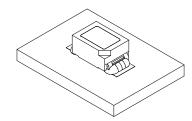
The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

## **Package Dimensions**









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- Specifications are subject to change without notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.





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**REV NO: V.3 CHECKED: Allen Liu**  DATE: OCT/05/2009 DRAWN: F.F.Zhou

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## **Selection Guide**

Part No.	lv (mcd) Dice Lens Type @ 20m			Viewing Angle [1]	
		2.	Min.	Тур.	201/2
AA3020SECK	Super Bright Orange (AlGaInP)	WATER CLEAR	70	250	90°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA
λD [1]	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA
С	Capacitance	Super Bright Orange	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Orange	2.1	2.5	V	I=20mA
lr	Reverse Current	Super Bright Orange		10	uA	V <sub>R</sub> =5V

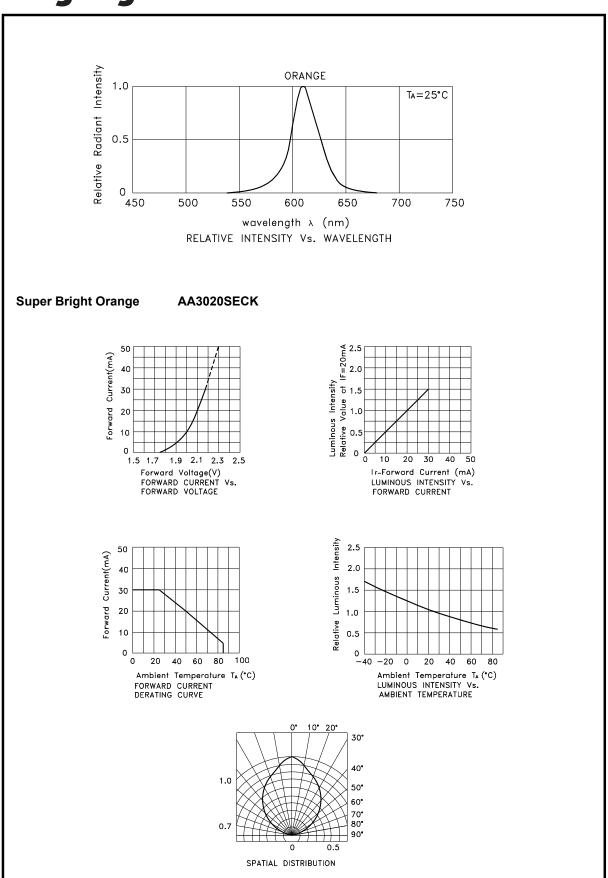
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Orange	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	195	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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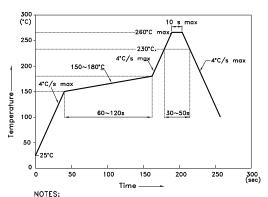
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### AA3020SECK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



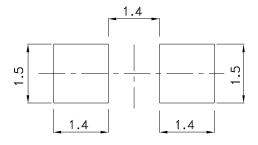
NOTES:

1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

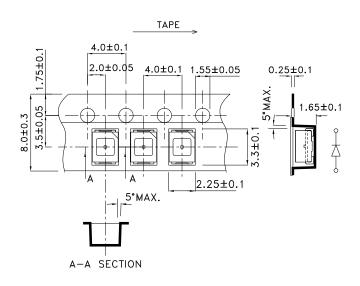
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

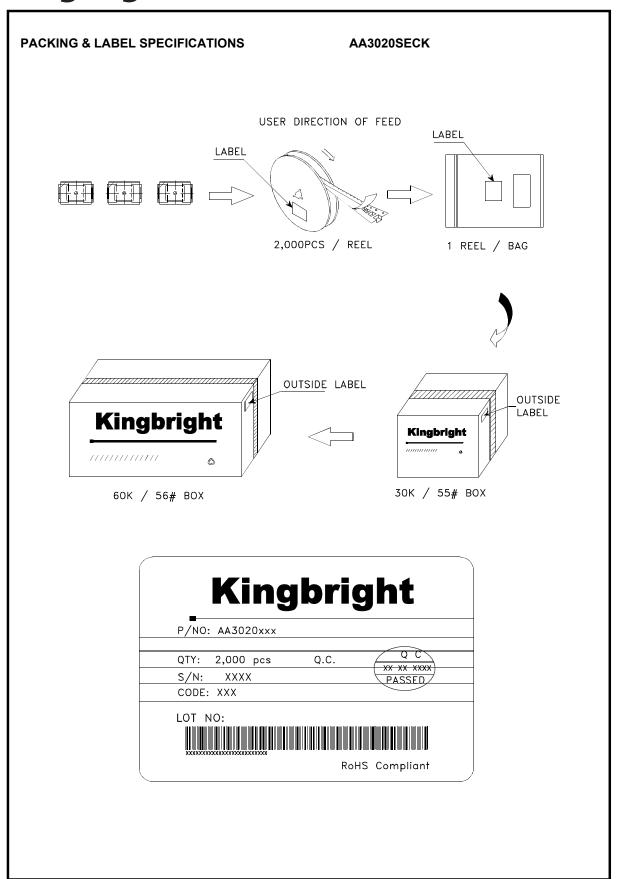
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



## Tape Dimensions (Units : mm)



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